

	L #	Hits	Search Text	DBs
1	L1	6059	(wiring adj board) and substrate and layers and electrodes	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
2	L2	6	(wiring adj board) and substrate and layers and electrodes and latice	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
3	L3	1	10/764522	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
4	L4	2	"20040243425"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT

	L #	Hits	Search Text	DBs
5	L5	2	"20040253425"	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
6	L6	2	("6887631").PN.	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWE NT
7	L7	6	("20030210361" "5716740" "6031512" "6133062" "6145981" "6376872").PN.	US- PGPUB; USPAT; USOCR
8	L8	28419	multilayer and substrate and electrodes	US- PGPUB; USPAT; USOCR
9	L9	5050	multilayer and substrate and electrodes and overlap	US- PGPUB; USPAT; USOCR
10	L10	160	9 and (interconnect\$4 near3 pattern)	US- PGPUB; USPAT; USOCR
11	L11	5	("20040124770" "20040183431" "6787063" "6809338" "6815903").PN.	US- PGPUB; USPAT; USOCR

	L #	Hits	Search Text	DBs
12	L12	11	("20030122495" "6290352" "6304670" "6312771" "6323596" "6341862" "6342321" "6364450" "6386700" "6394578" "6646375").PN.	US- PGPUB; USPAT; USOCR
13	L13	9	("5459596" "5510916" "5940059" "6066860" "6075580" "6108056" "6172721" "6320204" "6610997").PN.	US- PGPUB; USPAT; USOCR

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	40	wiring adj board.ti. and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 12:54
L2	5	"174"/\$.ccls. and(wiring adj board. ti.) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 12:55
L3	22	"174"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:03
L4	33	"361"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:24
L5	19	"349"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:27
L6	8	"365"/\$.ccls. and(wiring adj board) and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 13:34
L7	27	electro adj optical adj device.ti. and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 14:25
L8	145	electro adj optical adj device.ti. and(bank)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 14:26

L9	15	8 and(interconnect\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 14:26
S1	2562	wiring adj board and interconnecting	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:39
S2	43	wiring adj board and interconnecting adj line	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:39
S3	1	S2 and(substrate with bank)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:45
S4	34	S2 and(substrate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:49
S5	370	aoki adj. koji.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:50
S6	11	S5 and(board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:54
S7	821	(361/306.1-306.3).ccls. and(wiring adj board or board or wir\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 18:01

S8	7	S7 and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 17:59
S9	1409	(174/252-254).ccls. and(wiring adj board or board or wir\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/28 18:02
S10	19	S9 and(interconnect\$3 adj line\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2005/10/29 12:52